

July 1999 Revised July 1999

### 74VCX38

# Low Voltage Quad 2-Input NAND Gate with Open Drain Outputs and 3.6V Tolerant Inputs and Outputs

#### **General Description**

The VCX38 contains four 2-input NAND gates with open drain outputs. This product is designed for low voltage (1.65V to 3.6V)  $V_{CC}$  applications with I/O compatibility up to 3.6V.

The VCX38 is fabricated with advanced CMOS technology to achieve high-speed operation while maintaining CMOS low power dissipation.

#### **Features**

- $\blacksquare$  1.65V-3.6V  $\rm V_{CC}$  supply operation
- 3.6V tolerant inputs and outputs
- t<sub>PD</sub>
  - 2.8 ns max for 3.0V to 3.6V  $\rm V_{CC}$  3.7 ns max or 2.3V to 2.7V  $\rm V_{CC}$
- 6.7 ns max for 1.65V to 1.95V V<sub>CC</sub>

   Power-off high impedance inputs and outputs
- Static Drive (I<sub>OL</sub>)
- ±24 mA @ 3.0V V<sub>CC</sub> ±18 mA @ 2.3V V<sub>CC</sub>
- ±6 mA @ 1.65V V<sub>CC</sub>
- Uses patented Quiet Series™ noise/EMI reduction circuitry
- Latchup performance exceeds 300 mA
- ESD performance:

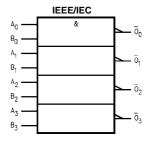
Human body model > 2000V Machine model > 250V

### Ordering Code:

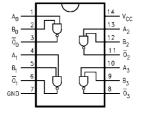
Order Number	Package Number	Package Description
74VCX38M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
74VCX38MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### **Logic Symbol**



### **Connection Diagram**



#### **Pin Descriptions**

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
$\overline{O}_n$	Outputs

Quiet Series™ is a trademark of Fairchild Semiconductor Corporation

### Absolute Maximum Ratings(Note 1)

## Recommended Operating Conditions (Note 3)

Supply Voltage (V <sub>CC</sub> )	-0.5V to +4.6V
DC Input Voltage (V <sub>I</sub> )	-0.5V to $+4.6V$
Output Voltage (V <sub>O</sub> ) (Note 2)	-0.5V to +4.6V

DC Input Diode Current ( $I_{IK}$ )  $V_{I} < 0V$  -50 mA

 $\label{eq:control} \begin{array}{lll} \text{DC Output Diode Current (I}_{OK}) & & & -50 \text{ mA} \\ \\ V_O < 0V & & -50 \text{ mA} \\ \\ \text{DC Output Source/Sink Current (I}_{OL}) & +50 \text{ mA} \\ \\ \text{DC V}_{CC} \text{ or Ground Current per} & \pm 100 \text{ mA} \\ \end{array}$ 

Supply Pin (I<sub>CC</sub> or Ground)

Storage Temperature Range ( $T_{stg}$ )  $-65^{\circ}C$  to  $+150^{\circ}C$ 

Power Supply

 $\begin{array}{ccc} \text{Operating} & 1.65 \text{V to } 3.6 \text{V} \\ \text{Data Retention Only} & 1.2 \text{V to } 3.6 \text{V} \\ \text{Input Voltage} & -0.3 \text{V to } 3.6 \text{V} \\ \end{array}$ 

0V to  $V_{CC}$ 

Output Voltage (V<sub>O</sub>)
Output Current in I<sub>OL</sub>

 $V_{CC} = 3.0 \text{V to } 3.6 \text{V}$   $\pm 24 \text{ mA}$   $V_{CC} = 2.3 \text{V to } 2.7 \text{V}$   $\pm 18 \text{ mA}$   $V_{CC} = 1.65 \text{V to } 2.3 \text{V}$   $\pm 6 \text{ mA}$ 

Free Air Operating Temperature ( $T_A$ )  $-40^{\circ}C$  to  $+85^{\circ}C$ 

Minimum Input Edge Rate ( $\Delta t/\Delta V$ )

 $V_{in} = 0.8V$  to 2.0V,  $V_{CC} = 3.0V$  10 ns/V

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: I<sub>O</sub> Absolute Maximum Rating must be observed.

Note 3: Floating or unused inputs must be held HIGH or LOW

### DC Electrical Characteristics (2.7 $V < V_{CC} \le 3.6V$ )

Symbol	Parameter	Conditions	(v)	Min	Max	Units
V <sub>IH</sub>	HIGH Level Input Voltage		2.7-3.6	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage		2.7-3.6		0.8	V
V <sub>OL</sub>	LOW Level Output Voltage	$I_{OL} = 100 \mu\text{A}$	2.7–3.6		0.2	
		I <sub>OL</sub> = 12 <b>mA</b>	2.7		0.4	V
		I <sub>OL</sub> = 18 mA	3.0		0.4	V
		I <sub>OL</sub> = 24 mA	3.0		0.55	
lı	Input Leakage Current	$0 \le V_I \le 3.6V$	2.7–3.6		±5.0	μΑ
I <sub>OFF</sub>	Power-Off Leakage Current	$0 \le (V_I, V_O) \le 3.6V$	0		10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	2.7–3.6		20	μА
		$V_{CC} \le V_I \le 3.6V$	2.7-3.6		±20	μΛ
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> -0.6V	2.7-3.6		750	μΑ

### DC Electrical Characteristics (2.3V $\leq$ $V_{CC} \leq$ 2.7V)

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
$V_{IH}$	HIGH Level Input Voltage		2.3–2.7	1.6		V
$V_{IL}$	LOW Level Input Voltage		2.3–2.7		0.8	V
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	2.3-2.7		0.2	
		I <sub>OL</sub> = 12 mA	2.3		0.4	V
		I <sub>OL</sub> = 18 mA	2.3		0.6	
I <sub>I</sub>	Input Leakage Current	0 ≤ V <sub>I</sub> ≤ 3.6V	2.3–2.7		±5.0	μΑ
I <sub>OFF</sub>	Power-Off Leakage Current	$0 \le (V_I, V_O) \le 3.6V$	0		10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	2.3–2.7		20	μΑ
		$V_{CC} \le V_1 \le 3.6V$	2.3-2.7		±20	

### DC Electrical Characteristics (1.65V $\leq$ $V_{\mbox{\footnotesize CC}}$ < 2.3V)

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
V <sub>IH</sub>	HIGH Level Input Voltage		1.65-2.3	0.65 x V <sub>CC</sub>		V
V <sub>IL</sub>	LOW Level Input Voltage		1.65-2.3		0.35 x V <sub>CC</sub>	V
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	1.65-2.3		0.2	V
		I <sub>OL</sub> = 6 mA	1.65	-40	0.3	V
I <sub>I</sub>	Input Leakage Current	0 ≤ V <sub>I</sub> ≤ 3.6V	1.65-2.3	C. A.	±5.0	μΑ
I <sub>OFF</sub>	Power-Off Leakage Current	$0 \le (V_I, V_O) \le 3.6V$	0	1	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	1.65-2.3		20	μΑ
		$V_{CC} \le V_1 \le 3.6 V$	1.65-2.3		±20	

### AC Electrical Characteristics (Note 4)

		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, C_L = 30 \text{ pF}, R_L = 500\Omega$						
Symbol	Parameter Parameter	V <sub>CC</sub> = 3.	.3V ±0.3V	$V_{CC}=2.$	5V ±0.2V	V <sub>CC</sub> = 1.8	3V ±0.15V	Units
		Min	Max	Min	Max	Min	Max	
t <sub>PZL</sub>	Propagation Delay	0.6	2.8	0.8	3.7	1.0	6.7	ns
t <sub>PLZ</sub>								
t <sub>OSHL</sub>	Output to Output Skew (Note 5)		0.5		0.5		0.75	ns
t <sub>OSLH</sub>		1						

Note 4: For C<sub>L</sub> = 50 pF, add approximately 300 ps to the AC maximum specification.

Note 5: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

### **Dynamic Switching Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C	Units
$V_{OLP}$	Quiet Output Dynamic Peak V <sub>OL</sub>	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	0.25	
			2.5	0.6	V
			3.3	0.8	
$V_{OLV}$	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 30 \text{ pF, } V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	-0.25	
			2.5	-0.6	V
			3.3	-0.8	

### Capacitance

Symbol	Parameter	Conditions	T <sub>A</sub> +25°C Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{I} = 0v \text{ OR } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	6	pF
C <sub>OUT</sub>	Output Capacitance	$V_{I} = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	7	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_I = 0V \text{ or } V_{CC}, f = 10 \text{ MHz}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	20	pF

### **AC Loading and Waveforms**

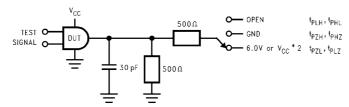
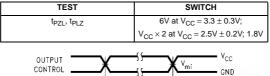


FIGURE 1. AC Test Circuit



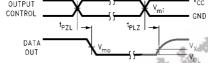
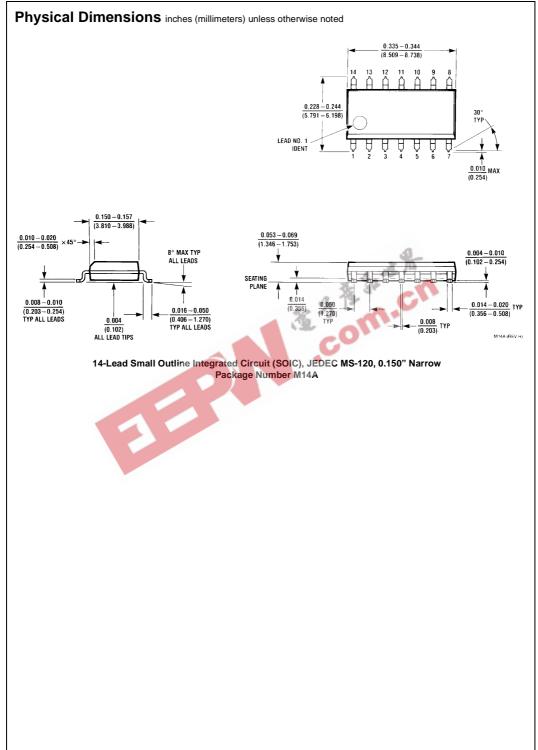
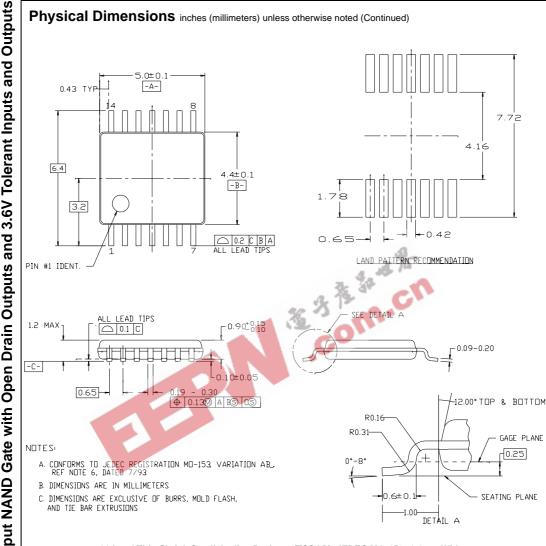


FIGURE 2. Waveform for Open Drain, Inverting and Non-inverting Functions

		186 3	0.
Symbol		V <sub>cc</sub>	
Oybo.	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V
V <sub>mi</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>mo</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>x</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V	V <sub>OL</sub> + 0.15V





#### 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

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